

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Daniel Wah Boon Low	05/20/2008
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Antibac Laboratories Pte. Ltd.
<b>Street Address:</b>	53 Ubi Avenue 1, #05-55 Paya Ubi Industrial Park
<b>City:</b>	Singapore
<b>State/Country:</b>	SINGAPORE
<b>Postal Code:</b>	408934
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	29318257
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(408)286-8932
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	(408) 286-8933
<b>Email:</b>	gmok@iplg.com
<b>Correspondent Name:</b>	Intellectual Property Law Group LLP
<b>Address Line 1:</b>	12 South First Street, 12th Floor
<b>Address Line 4:</b>	San Jose, CALIFORNIA 95113
<b>ATTORNEY DOCKET NUMBER:</b>	YSAP.ANTIBAC.DP2
<b>NAME OF SUBMITTER:</b>	Gregory Mok
<b>Total Attachments: 1</b> source=ASSIGNMENT#page1.tif	

OP \$40.00 29318257

### ASSIGNMENT

WHEREAS, I, Daniel Wah Boon Low, (hereinafter referred to as "ASSIGNOR"), is the owner of application for United States Letters Patent, Application No. TBD, filed on TBD for the invention entitled "Air Purifier"; and is the owner of all rights, title and interest in and to the invention illustrated, described and claimed in said application for Letters Patent.

WHEREAS, Antibac Laboratories Pte. Ltd., a corporation organized and existing under the laws of the country of Singapore, having its principal place of business at 53 Ubi Avenue 1, #05-55 Paya Ubi Industrial Park, Singapore, Singapore 408934 (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring my entire right, title and interest in and to the invention and said application for Letters Patent;

NOW THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, said ASSIGNOR, has sold, assigned and set over, and by these presents does hereby sell, assign and set over unto the said ASSIGNEE, its legal representatives, successors and assigns, its entire rights, title and interest in and to said application to United States Letters Patent, and the invention disclosed, described or claimed in said application to Letters Patent, together with all divisions, reissues, continuations and extensions thereof, and any and all rights of recovery for past infringement of said application to Letters Patent.

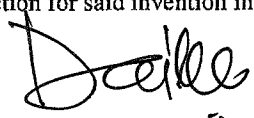
I also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application for patent and any applications throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and

I further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

I hereby further agree that I will communicate to said ASSIGNEE, or its successors, assigns and legal representatives, any facts known to me respecting any improvements; and, at the expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, make all lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper protection for said invention in all countries.

20.5.08

Date



Name: Daniel Wah Boon Low

STATE OF \_\_\_\_\_ )

COUNTY OF Singapore ) ss.

On this 20th day of May, 2008, before me, Harpal Singh a Notary Public in and for the State and County aforesaid, personally appeared Daniel Wah Boon Low known by me to be the person of the above name who signed and sealed the foregoing instrument, and acknowledged the same to be his own free act and deed.

IN WITNESS WHEREOF, I have hereunto set my hand and seal this 20th day of May, 2008.

(seal)

Notary Public

